

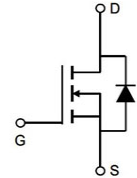
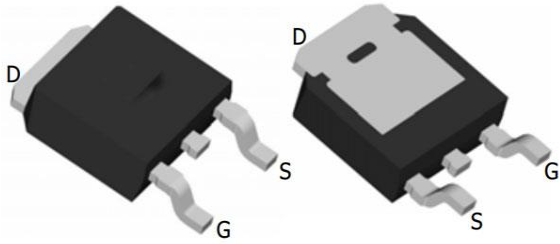
30V /55A Single N Power MOSFET
General Description

30V /55A Single N Power MOSFET

 Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5\text{ V}$

Pb-free lead plating; RoHS compliant

V_{DS}	30	V
$R_{DS(on),TYP@V_{GS}=10V}$	3.9	m Ω
$R_{DS(on),TYP@V_{GS}=4.5}$	6.7	m Ω
I_D	55	A



Part ID	Package Type	Marking	Tape and reel information
SM4146T9RL	TO-252	55N03	2500


 100% UIS Tested
 100% Kg Tested

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	20	$\pm V$
Continuous Drain Current ^A	I_D	$T_A=25^\circ C$	A
		$T_A=70^\circ C$	
Pulsed Drain Current ^B	I_{DM}	88.0	
Avalanche Current ^C	I_{AR}	17.6	
Repetitive avalanche energy $L=0.1\text{mH}$ ^C	E_{AR}	40.5	mJ
Power Dissipation ^A	P_D	$T_A=25^\circ C$	W
		$T_A=70^\circ C$	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	23	35	$^\circ C/W$
Maximum Junction-to-Ambient ^A		Steady State	47	57
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	14	22	$^\circ C/W$



STATIC PARAMETERS

Symbol	Parameter	Conditions	Min	Typ	Max	Units
BV _{DSS}	Drain-Source Breakdown Voltage	I _D = -250uA, V _{GS} = 0V	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1 5	uA
I _{GSS}	Gate-Body leakage current	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} I _D = 250µA	1.5	2.3	3	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A		3.9	5.6	mΩ
		V _{GS} =4.5V, I _D =20A		6.7	9.5	
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =20A		67		S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =182V		0.72	1	V
I _S	Maximum Body-Diode Continuous Current				55	A

DYNAMIC PARAMETERS

Symbol	Parameter	Conditions	Min	Typ	Max	Units
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz		2037	2485	pF
C _{oss}	Output Capacitance			375	461	pF
C _{rss}	Reverse Transfer Capacitance			220	261	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			2.3	Ω

SWITCHING PARAMETERS

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =20A		16		nC
Q _g 4.5V)	Total Gate Charge			8		
Q _{gs}	Gate Source Charge			3.22		
Q _{gd}	Gate Drain Charge			4.6		
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =15V, R _L =0.75Ω, R _{GEN} =3Ω		5		ns
t _r	Turn-On Rise Time			4		
t _{D(off)}	Turn-Off DelayTime			14		
t _f	Turn-Off Fall Time			4.5		
t _{rr}	Body Diode Reverse Recovery Time	I _F =-8A, dI/dt=500A/µs		10		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =18A, dI/dt=500A/µs		15		nC



